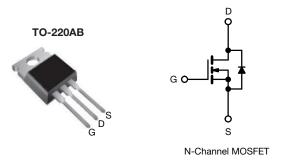
**Vishay Siliconix** 



## **Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.21				
Q <sub>g</sub> max. (nC)	110				
Q <sub>gs</sub> (nC)	33				
Q <sub>gd</sub> (nC)	54				
Configuration	Single				

#### **FEATURES**

- Low gate charge Q<sub>g</sub> results in simple drive requirement
- Improved gate, avalanche, and dynamic dV/dt RoHS<sup>a</sup>
  Available
- Fully characterized capacitance and avalanche voltage and current
- Low R<sub>DS(on)</sub>
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching
- · Hard switched and high frequency circuits

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFB20N50KPbF
Leau (Fb)-liee	SiHFB20N50K-E3

<b>ABSOLUTE MAXIMUM RATINGS (T</b> C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	500	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	20	
		T <sub>C</sub> = 100 °C		12	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	80	
Linear derating factor				2.2	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	330	mJ
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	20	А
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	28	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	280	W
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	10	V/ns
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	- °C
Mounting torque	6-32 or l	M3 screw		10	N

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. Starting  $T_J$  = 25 °C, L = 1.6 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 20 A

c.  $I_{SD} \leq 20$  A, dI/dt  $\leq 350$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C

d. 1.6 mm from case

1



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	58		
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.45		

= 25 ÞC,	SYMBOL	TES	ST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>					
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.61	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	3.0	-	5.0	V
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zous asta usltana dusia sumant		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> = 0 V	-	-	50	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 12 A <sup>b</sup>	-	0.21	0.25	Ω
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 12 A	11	-	-	S
Dynamic		•			•	•	
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	2870	-	
Output capacitance	C <sub>oss</sub>		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		320	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	34	-	
	C <sub>oss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	3480	-	pF
Output capacitance			V <sub>DS</sub> = 400 V, f = 1.0 MHz	-	85	-	
Effective output capacitance	C <sub>oss</sub> eff.		V <sub>DS</sub> = 0 V to 400 V	-	160	-	
Total gate charge	Qg			-	-	110	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, V <sub>DS</sub> = 400 V see fig. 6 and 13 <sup>b</sup>	-	-	33	nC
Gate-drain charge	Q <sub>gd</sub>		see lig. 0 and 15	-	-	54	
Turn-on delay time	t <sub>d(on)</sub>		•	-	22	-	
Rise time	t <sub>r</sub>	- V <sub>DD</sub>	= 250 V, I <sub>D</sub> = 20 A	-	74	-	1
Turn-off delay time	t <sub>d(off)</sub>	R <sub>g</sub> = 7.5 Ω,	$V_{GS} = 10$ V, see fig. 10 <sup>b</sup>	-	45	-	ns
Fall time	t <sub>f</sub>			-	33	-	
Gate input resistance	Rg	f = 1	MHz, open drain	0.3	-	2.9	Ω
Drain-Source Body Diode Characteristic	s	•			•	•	
Continuous source-drain diode current	١ <sub>S</sub>	showing the	MOSFET symbol showing the		-	20	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction		-	-	80	A
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, $I_{S} = 20 \text{ A}, V_{GS} = 0 \text{ V}^{\text{b}}$	-	-	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>			-	520	780	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	– 1 <sub>J</sub> = 25 °C, I <sub>F</sub>	= 20 A, dl/dt = 100 A/µs <sup>b</sup>	-	5.3	8.0	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic tu	urn-on time is negligible (turn	-on is dor	ninated b	vleand	<u> </u>

Notes

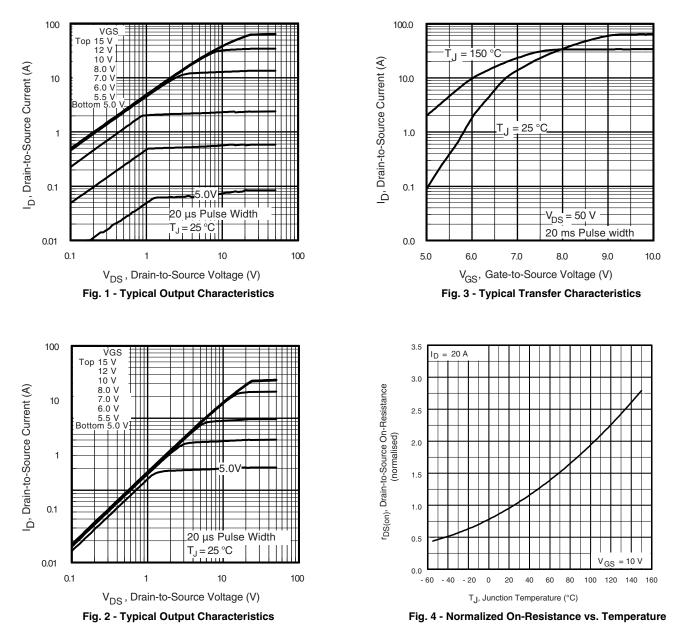
a. Repetitive rating; pulse width limited by maximum junction temperature

b. Pulse width  $\leq$  400 µs; duty cycle  $\leq$  2 %

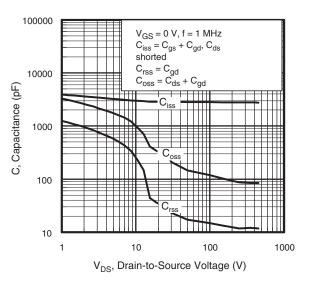


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

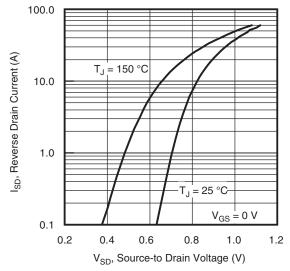


Fig. 7 - Typical Source-Drain Diode Forward Voltage

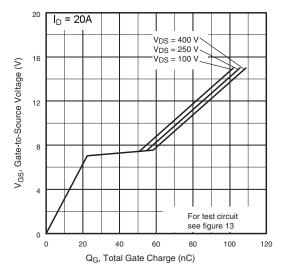


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

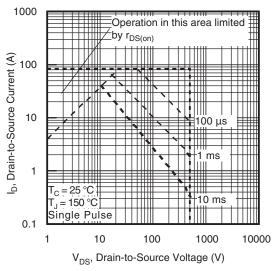
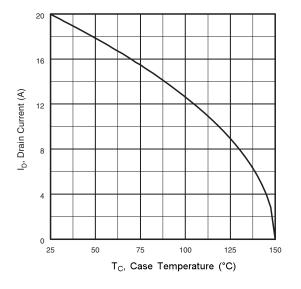


Fig. 8 - Maximum Safe Operating Area

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#### Fig. 9 - Maximum Drain Current vs. Case Temperature

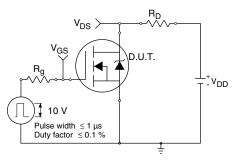


Fig. 10a - Switching Time Test Circuit

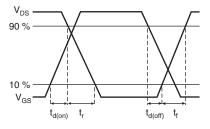
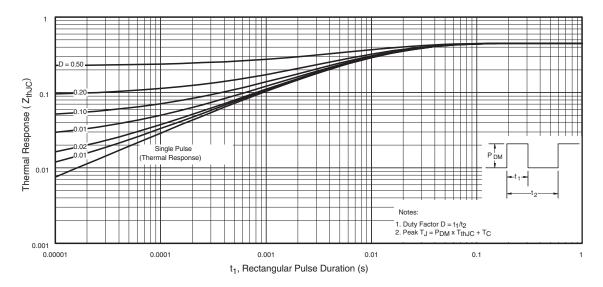


Fig. 10b - Switching Time Waveforms





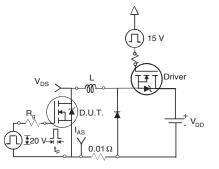


Fig. 12a - Unclamped Inductive Test Circuit

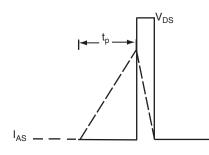


Fig. 12b - Unclamped Inductive Waveforms

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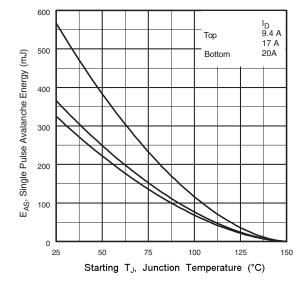


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

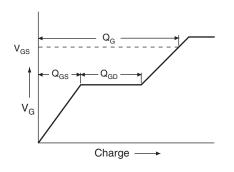


Fig. 13a - Basic Gate Charge Waveform

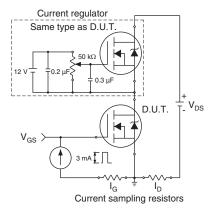
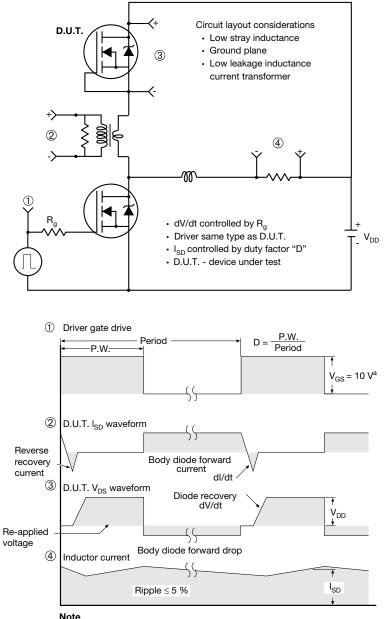


Fig. 13b - Gate Charge Test Circuit



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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

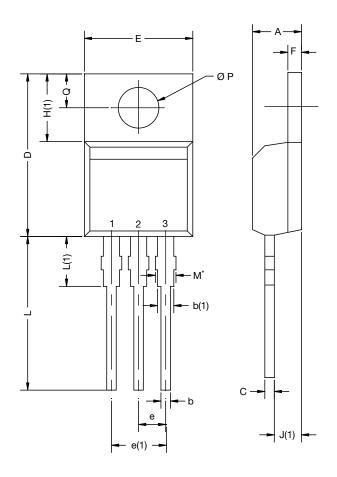
Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

#### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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